

OCT 26 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of:
Arvelo, et al.

Serial No.: 10/672,494

Filed: September 26, 2003

Group Art Unit: 2835

Examiner: Vortman, Anatoly

Atty. Docket No.: FIS920030258US1

For: METHOD AND STRUCTURE FOR COOLING A DUAL CHIP MODULE
WITH ONE HIGH POWER CHIP

Certificate of Transmission by Facsimile

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being facsimile transmitted to the United
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Pamela M. Riley

AMENDMENT UNDER 37 C.F.R. §1.111

Mail Stop Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This amendment is in response to the Office Action mailed August 3, 2005,
setting a three-month statutory period for response. Therefore, this amendment is timely
filed. Please amend the above-identified patent application as follows:

10/672,494

1